# 2SB1347

# Silicon PNP triple diffusion planar type

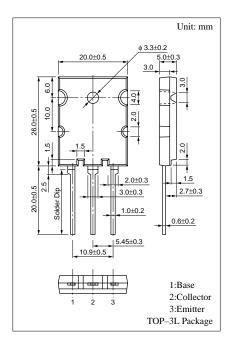
For high power amplification Complementary to 2SD2029

#### Features

- Satisfactory foward current transfer ratio h<sub>FE</sub> vs. collector current I<sub>C</sub> characteristics
- Wide area of safe operation (ASO)
- High transition frequency f<sub>T</sub>
- Optimum for the output stage of a HiFi audio amplifier

### Absolute Maximum Ratings (T<sub>C</sub>=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to base voltage		$V_{CBO}$	-160	V	
Collector to emitter voltage		$V_{CEO}$	-160	V	
Emitter to base voltage		$V_{\rm EBO}$	-5	V	
Peak collector current		$I_{CP}$	-20	A	
Collector current		$I_{C}$	-12	A	
Collector power	T <sub>C</sub> =25°C	D	120	337	
dissipation	Ta=25°C	$P_{C}$	3.5	W	
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	



## Electrical Characteristics (T<sub>C</sub>=25°C)

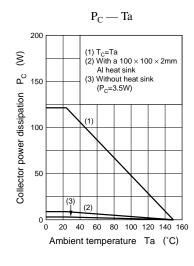
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = -160V, I_E = 0$			-50	μA
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = -3V, I_C = 0$			-50	μA
	h <sub>FE1</sub>	$V_{CE} = -5V, I_{C} = -20mA$	20			
Forward current transfer ratio	h <sub>FE2</sub> *	$V_{CE} = -5V, I_{C} = -1A$	60		200	
	h <sub>FE3</sub>	$V_{CE} = -5V, I_{C} = -8A$	20			
Base to emitter voltage	V <sub>BE</sub>	$V_{CE} = -5V, I_{C} = -8A$			-1.8	V
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -8A, I_B = -0.8A$			-2.0	V
Transition frequency	$f_T$	$V_{CE} = -5V, I_{C} = -0.5A, f = 1MHz$		15		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -10V, I_E = 0, f = 1MHz$		400		pF

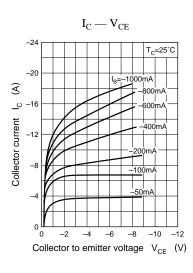
#### \*h<sub>FE2</sub> Rank classification

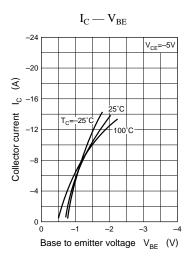
Rank	Q	S	P	
h <sub>FE2</sub>	60 to 120	80 to 160	100 to 200	

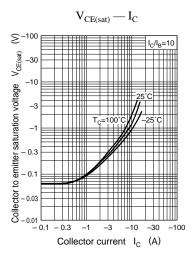
Panasonic

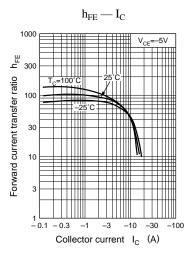
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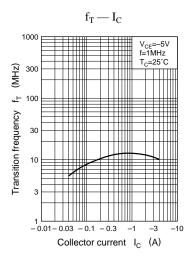


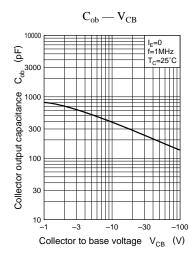


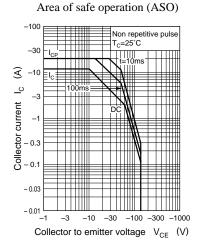






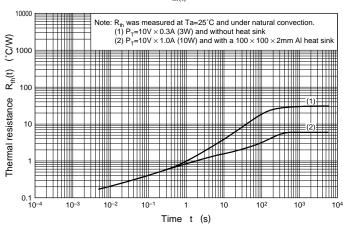






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